

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	CORRECTIVE ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	Corrective Assignment to correct the Fourth Assignor's Name to AKIHIKO MOROFUJI previously recorded on Reel 021244 Frame 0955. Assignor(s) hereby confirms the assignment.

**CONVEYING PARTY DATA**

Name	Execution Date
Atsushi KOMIYA	06/27/2008
Hiroyuki HONDA	06/27/2008
Takuya FUJIKAWA	06/27/2008
Akihiko MOROFUJI	06/27/2008

**RECEIVING PARTY DATA**

<b>Name:</b>	TOYO SEIKAN KAISHA, LTD.
<b>Street Address:</b>	1-3-1, Uchisaiwaicho, Chiyoda-ku
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	1008522

**PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	11575435

**CORRESPONDENCE DATA**

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<b>ATTORNEY DOCKET NUMBER:</b>	071324
<b>NAME OF SUBMITTER:</b>	Sadao Kinashi

**PATENT**

Total Attachments: 3

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TO: WESTERMAN, HATTORI, DANIELS &amp; ADRIAN, LL COMPANY: 1250 CONNECTICUT AVENUE,

## PATENT ASSIGNMENT

Electronic Version v1.1  
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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Atsushi KOMIYA</td> <td>06/27/2008</td> </tr> <tr> <td>Hiroyuki HONDA</td> <td>06/27/2008</td> </tr> <tr> <td>Takuya FUJIKAWA</td> <td>06/27/2008</td> </tr> <tr> <td>Akihito MOROFUJI</td> <td>06/27/2008</td> </tr> </tbody> </table>		Name	Execution Date	Atsushi KOMIYA	06/27/2008	Hiroyuki HONDA	06/27/2008	Takuya FUJIKAWA	06/27/2008	Akihito MOROFUJI	06/27/2008
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NAME OF SUBMITTER:	Sadao Kinashi										
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OP \$40.00 11575435

USPTO

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TO: WESTERMAN, HATTORI, DANIELS & ADRIAN, LL COMPANY: 1250 CONNECTICUT AVENUE,

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# U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by  
**TOYO SEIKAN KAISHA, LTD.**

(Insert ASSIGNEE's Name(s) Address(es))

**1-3-1, Uchisaiwaicho, Chiyoda-ku Tokyo 1008522**

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

**FLAT CONTAINER COMPRISING THERMOPLASTIC RESIN AND METHOD FOR MOLDING THE SAME**

(\*If the assignment is being filed after the filing of the application, this section must be completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

\* filed on March 16, 2007 Serial No. 11/575,435

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

<u>Atsushi Komiya.</u> (Signature)	<u>Atsushi KOMIYA</u> (Type Name)	<u>June 27, 2008.</u> (Date)
<u>Hiroyuki Honda</u> (Signature)	<u>Hiroyuki HONDA</u> (Type Name)	<u>June 27, 2008</u> (Date)
<u>Takuya Fujikawa</u> (Signature)	<u>Takuya FUJIKAWA</u> (Type Name)	<u>June 27, 2008</u> (Date)
<u>Akihiko Morofuji</u> (Signature)	<u>Akihiko MOROFUJI</u> (Type Name)	<u>June 27, 2008</u> (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)
_____ (Signature)	_____ (Type Name)	_____ (Date)

NO LEGALIZATION REQUIRED